

60V N-Channel Trench MOSFET

General Description

- Trench Power technology
- Low R_{DS(ON)}
- Low Gate Charge
- Optimized for fast-switching applications

Applications

- Synchronous Rectification in DC/DC and AC/DC Converters
- Isolated DC/DC Converters in Telecom and Industrial

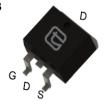
Product Summary

 $\begin{array}{ll} V_{DS} & 60V \\ I_{D} \mbox{ (at V_{GS}=$10V)} & 145A \\ R_{DS(ON)} \mbox{ (at V_{GS}=$10V)} & < 4.8 m \Omega \end{array}$

100% UIS Tested

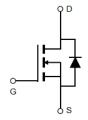


TO-263



TO-220





| Part Number | Package Type | Form | Marking |
|-------------|--------------|-------------|------------|
| TTB145N06A | TO-263 | Tape & Reel | TTB145N06A |
| TTP145N06A | TO-220 | Tube | TTP145N06A |

Absolute Maximum Ratings (T_A =25°C unless otherwise noted)

| Parameter | | Symbol | Maximum | Units |
|--|-----------------------|-----------------------------------|------------|-------|
| Drain-Source Voltage | | V _{DS} | 60 | V |
| Gate-Source Voltage | | V _{GS} | ±20 | V |
| Continuous Drain Current B | T _C =25°C | I _D | 105 | Δ. |
| | T _C =100°C | | 105 | А |
| Pulsed Drain Current ^A | | I _{DM} | 435 | А |
| Avalanche Current A | | I _{AS} | 57 | А |
| Single Pulse Avalanche Energy L =0.3mH A | | E _{AS} | 487 | mJ |
| Power Dissipation ^C | T _C =25°C | P _D | 217 | W |
| | T _C =100°C | | 108 | W |
| Junction and Storage Temperature Range | | T _J , T _{STG} | -55 to 175 | °C |
| Thermal Characteristics | | | | |

Thermal Characteristics

| Parameter | | Symbol | Maximum | Units | | |
|-----------------------------|--------------|------------------|---------|-------|--|--|
| Maximum Junction-to-Case | Steady-State | R _{eJC} | 0.69 | °C/W | | |
| Maximum Junction-to-Ambient | Steady-State | $R_{\Theta JA}$ | 100 | °C/VV | | |



| Electrical Characteristics(T _J =25°C unless otherwise noted) | | | | | | | | |
|---|---|--|--|-------|------|------|-------|--|
| Symbol | Daramatar | Conditions | | Value | | | 11-26 | |
| Symbol | Parameter | | | Min | Тур | Max | Units | |
| STATIC P | ARAMETERS | | | | | - | | |
| BV_{DSS} | Drain-Source Breakdown Voltage | $I_D = 250 \mu A, V_{GS} = 0 V$ | | 60 | - | | V | |
| ı | Zero Gate Voltage Drain Current | V _{DS} =60V, V _{GS} =0V | T _J =25°C | - | - | 1 | | |
| I _{DSS} | Zelo Gale Vollage Dialii Guiletti | V _{DS} =00 V, V _{GS} =0 V | T _J =125°C | 1 | - | 100 | μA | |
| I_{GSS} | Gate-Body Leakage Current | $V_{DS} = 0V, V_{GS} = \pm 20V$ | | 1 | 1 | ±100 | nA | |
| $V_{GS(th)}$ | Gate Threshold Voltage | $V_{DS} = V_{GS}, I_{D} = 250 \mu A$ | | 2 | 3 | 4 | V | |
| R _{DS(ON)} | Static Drain-Source On-Resistance | V _{GS} =10V, I _D =30A | | | 3.8 | 4.8 | mΩ | |
| g _{FS} | Forward Transconductance | V _{DS} =5V, I _D =20A | | | 38 | | S | |
| V_{SD} | Diode Forward Voltage | I _S =30A, V _{GS} =0V | I _S =30A, V _{GS} =0V | | | 1 | V | |
| I _s | Maximum Body-Diode Continuous Current B | | | | | 105 | Α | |
| DYNAMIC | PARAMETERS | | | | | | | |
| C _{iss} | Input Capacitance | $V_{GS} = 0V$, $V_{DS} = 30V$, $f = 1MH_Z$ $f = 1MH_Z$ | | | 6819 | | pF | |
| C _{oss} | Output Capacitance | | | | 481 | | | |
| C _{rss} | Reverse Transfer Capacitance | | | | 461 | | | |
| R_g | Gate Resistance | | | | 1.6 | | Ω | |
| SWITCHIN | NG PARAMETERS | • | | | | | | |
| Q_g | Total Gate Charge | | V _{GS} =10V,V _{DS} =30V, I _D =20A | | 125 | | | |
| Q_{gs} | Gate Source Charge | $V_{GS} = 10V, V_{DS} = 30V, V_{DS} = 10V, $ | | | 31.6 | | nC | |
| Q_{gd} | Gate Drain Charge | | | | 36.7 | | | |
| t _{D(on)} | Turn-On Delay Time | $V_{GS} = 10V, V_{DS} = 30V, I_{D} = 20A,$ $R_{G} = 2.5\Omega$ | | | 25 | | | |
| t _r | Turn-On Rise Time | | | | 20 | | ns | |
| T _{D(off)} | Turn-Off Delay Time | | | | 72 | | | |
| t _f | Turn-Off Fall Time | | | | 31 | | | |
| t _{rr} | Body Diode Reverse Recovery Time | 1 -200 4:/44 400 4/ | | | 36 | | ns | |
| Q _{rr} | Body Diode Reverse Recovery Charge | I _F =20A, di/dt =100A/μs | | | 60 | | nC | |

- A. Single pulse width limited by maximum junction temperature.
- B. The maximum current rating is package limited.
- C. The power dissipation P_D is based on $T_{J(MAX)}$ =175°C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.

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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

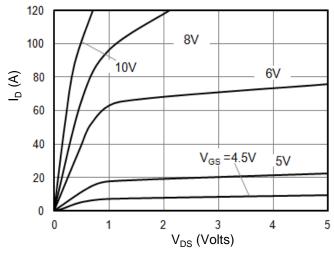


Figure 1: On-Region Characteristics

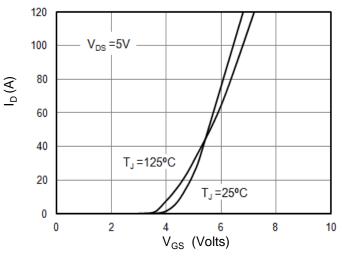


Figure 2: Transfer Characteristics

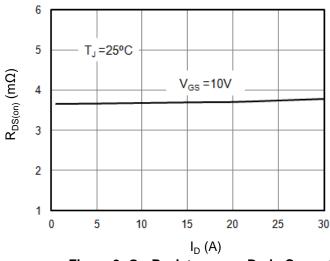


Figure 3: On-Resistance vs. Drain Current

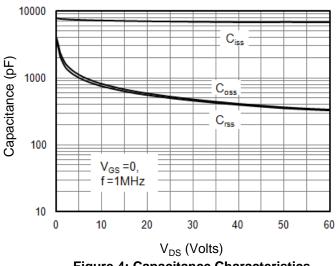


Figure 4: Capacitance Characteristics

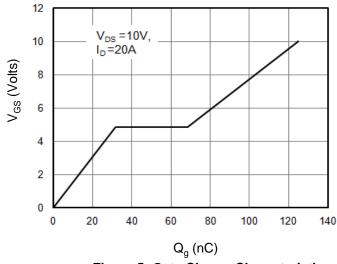


Figure 5: Gate Charge Characteristics

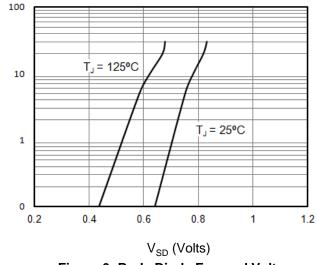


Figure 6: Body Diode Forward Voltage

I_s (A)



V_{DS} (Volts)

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

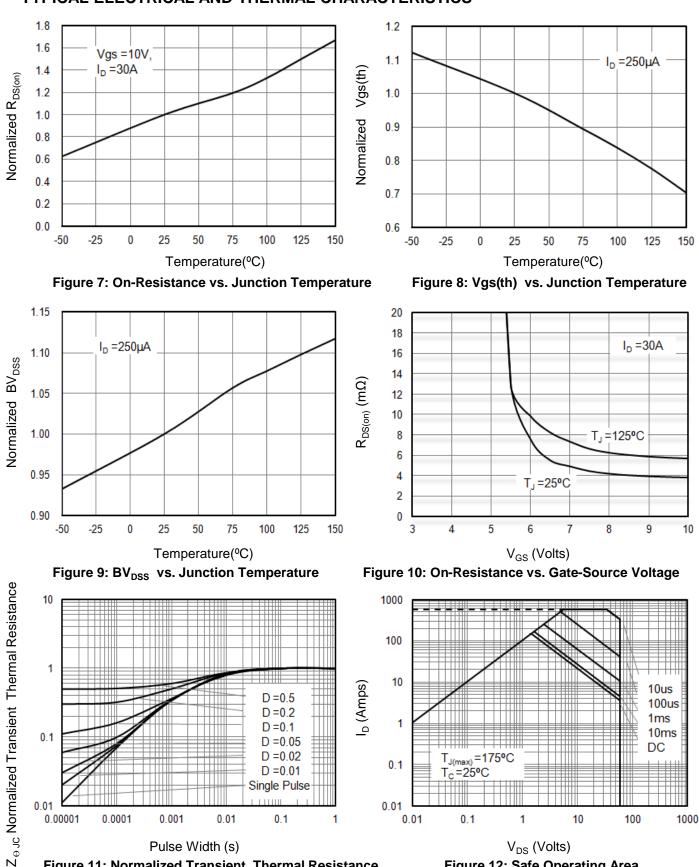


Figure 11: Normalized Transient Thermal Resistance Figure 12: Safe Operating Area

Pulse Width (s)

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Figure A: Gate Charge Test Circuit and Waveforms

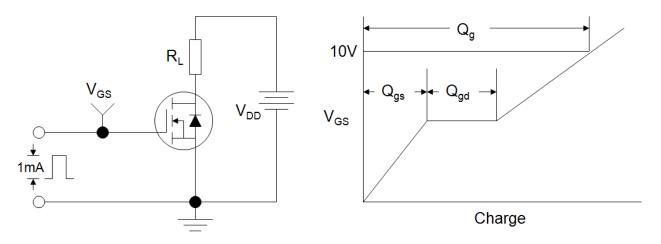


Figure B: Resistive Switching Test Circuit and Waveforms

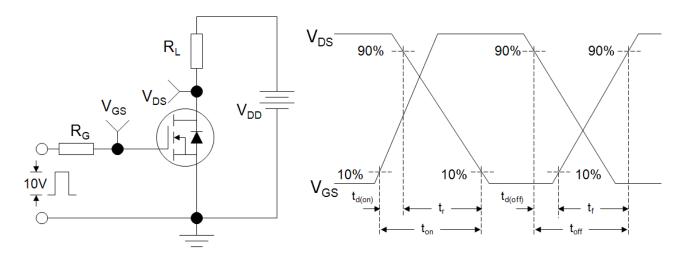
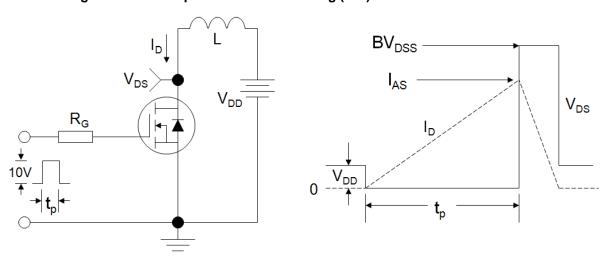


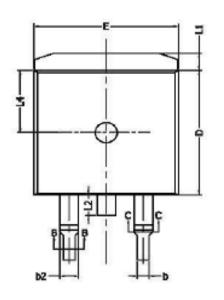
Figure C: Unclamped Inductive Switching (UIS) Test Circuit and Waveforms

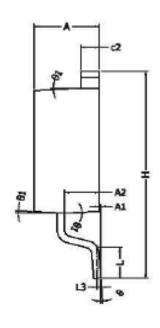


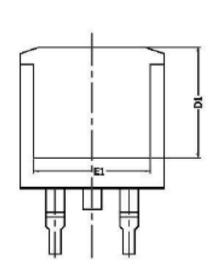
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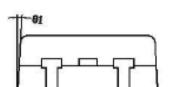


TO-263(集佳)







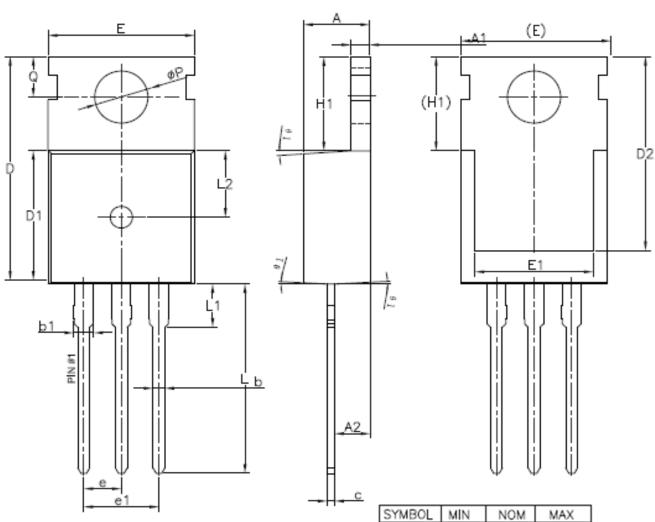


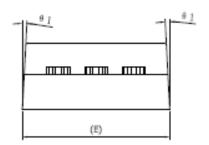
COMMON DIMENSIONS (UNITS OF MEASURE =MILLIMETER)

| SYMBOL | MIN | NOM | MAX | | |
|--------|----------|-------|-------|--|--|
| A | 4.40 | 4.50 | 4.60 | | |
| A1 | 0 | 0.10 | 0.25 | | |
| A2 | 2.20 | 2.40 | 2.60 | | |
| b | 0.76 | | 0.89 | | |
| b1 | 0.75 | 0.80 | 0.85 | | |
| b2 | 1.23 | | 1.37 | | |
| b3 | 1.22 | 1.27 | 1.32 | | |
| C | 0.47 | | 0.60 | | |
| c1 | 0.46 | 0.51 | 0.56 | | |
| c2 | 1.25 | 1.30 | 1.35 | | |
| D. | 9.10 | 9.20 | 9.30 | | |
| D1 | 8.00 | | 1000 | | |
| E | 9.80 | 9.90 | 10.00 | | |
| E1 | 7.80 | | - | | |
| е | 2.54 BSC | | | | |
| Н | 14.90 | 15.30 | 15.70 | | |
| L | 2.00 | 2.30 | 2.60 | | |
| L1 | 1.17 | 1.27 | 1.40 | | |
| 12 | | | 1.75 | | |
| L3 | 0.25BSC | | | | |
| L4 | 4.60 REF | | | | |
| 0 | Oo. | 80 | | | |
| 01 | 1° | 3° | 5° | | |



TO-220 (集佳)





| SYMBOL | MIN | NOM | MAX | | |
|--------|-----------|---------|-------|--|--|
| Α | 4.40 | 4.50 | 4.60 | | |
| A1 | 1.27 | 1.30 | 1.33 | | |
| A2 | 2.30 | 2.40 | 2.50 | | |
| b | 0.70 | _ | 0.90 | | |
| b1 | 1.27 | 1 | 1.40 | | |
| С | 0.45 | 0.50 | 0.60 | | |
| D | 15.30 | 15.70 | 16.10 | | |
| D1 | 9.10 | 9.20 | 9.30 | | |
| D2 | 13.10 | _ | 13.70 | | |
| Ε | 9.70 | 9.90 | 10.20 | | |
| E1 | 7.80 | 8.00 | 8.20 | | |
| е | 2.54BSC | | | | |
| e1 | | 5.08BSC | ; | | |
| H1 | 6.30 | 6.50 | 6.70 | | |
| L | 12.78 | 13.08 | 13.38 | | |
| L1 | _ | _ | 3.50 | | |
| L2 | 4.60REF | | | | |
| øΡ | 3.55 3.60 | | 3.65 | | |
| Q | 2.73 | _ | 2.87 | | |
| 0 1 | 1* | 3* | 5* | | |



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DMN2080UCB4-7 DMN61D9UWQ-13 US6M2GTR DMN31D5UDJ-7 DMP22D4UFO-7B DMN1006UCA6-7 DMN16M9UCA6-7
STF5N65M6 IRF40H233XTMA1 STU5N65M6 DMN6022SSD-13 DMN13M9UCA6-7 DMTH10H4M6SPS-13 DMN2990UFB-7B
IPB80P04P405ATMA2 2N7002W-G MCAC30N06Y-TP MCQ7328-TP BXP7N65D BXP4N65F AOL1454G WMJ80N60C4 BXP2N20L
BXP2N65D BXT1150N10J BXT1700P06M TSM60NB380CP ROG RQ7L055BGTCR DMNH15H110SK3-13 SLF10N65ABV2
BSO203SP BSO211P IPA60R230P6 IPA60R460CE